

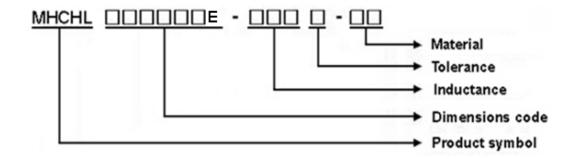
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer :			超利維	
Drawing No :			IE1-8A03	208
Drawing No .			IL I-OAU	
Quantity:	X	Pcs.	Date :	2018/10/25
Chilisin P/N:		МНСЬ	HL201610E	E-R47M-Q8
	SPI	ECIFIC	ATION	
	A(CCEPTE	D BY:	
COMPONENT				
ENGINEER				
ELECTRICAL				
ENGINEER				
MECHANICAL				
ENGINEER				
APPROVED				
REJECTED				
奇力新電子股份有限公司 Chilisin Electronics Corp No. 29, Alley 301, Tehhsin Rd., Hukou, Hsinchu 303, Taiwan TEL: +886-3-599-2646 FAX: +886-3-599-9176 E-mail: sales@chilisin.com http://www.chilisin.com			Chilisin Electro)-8773-0251~3 9-8773-0232
奇力新電子(越南廠)有限 Chilisin Electronics (Vietnam) Li No 143 - 145, Road No 10, VSII Phong, Lap Le Commune, Thuy Dist, Haiphong City, Vietnam Tel: 84-316 255 688 Fax: 84- 689 E-mail: sales@chilisin.com	mited P Hai Nguyen		HuNan Chilisir No. 8, Shaziac	(湖南廠)有限公司 n Electronics Technology Co., Ltd o Liangshuijing Town, Yuanling ua City, Hunan Province 419601, 67-5882
Drawn by 長鈺雯 Chang.Yuwen	⊒E ∆−	Checked 函数 Chang	-	Approved by JACKY鍾 Jacky.Chu n

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-40 \,^{\circ}\text{C} \sim 125 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: - 4 0 °C ~ 1 2 5 °C(after PCB)

- 5° C ~ 3° C, Humidity 4° 5 % ~ 8° 5 % (before PCB)

4 Marking:

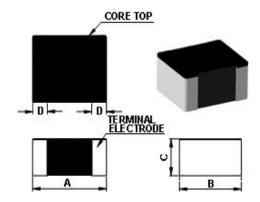
No Marking

5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



6 Configuration and Dimensions:



Dimensions in mm

TYPE	MHCHL201610E
А	2.0±0.2
В	1.6±0.2
С	1.0 max
D	0.5±0.3

7 Electrical Characteristics:

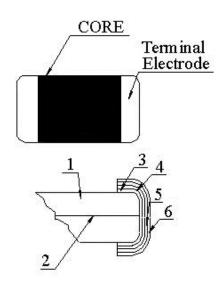
Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	
MHCHI 201610F-R47M-Q8	0.47	20	2MHz.0.2V	4.0(4.3)	4.8(5.0)	26(22)	

NOTE

- 1. Operating temperature range $\,$ - $\,$ 4 0 $^{\circ}\text{C} \sim$ 1 2 5 $^{\circ}\text{C} (Including self - temperature rise)$
- 2.Isat for Inductance drop 30% from its value without current.
- 3.Irms for a 40°C temperature rise from 25°C ambient.
- 4.Rated current: Isat or Irms, whichever is smaller
- 5.All test data is referenced to 25°C ambient
- 6. Absolute maximum voltage 20VDC



8 MHCHL201610E Series 8.1 Construction:



8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

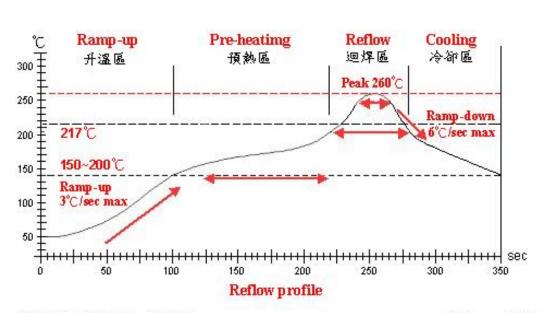


9 Reliability Of Molding power inductors 1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate
		microscope of CASTOR MZ-45 20X	Oscillation Frequency: 10 to 55 to 10Hz for 1min
		Inductance change shall be	Amplitude: 1.5mm
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°C, 1min
		More than 75% of the terminal	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5°C
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150℃, 1min
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5°C
		-	Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
		Chip	then apply a force in the direction of the arrow.
		O'''P → F	Force : 5N
			Keeping Time: 10±1sec
		Mounting Pad	

1-2.0	nvironmental Performance						
No	Item	Specification	Test Method				
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:				
		Inductance:within±20% of	Step	Temperature (°C)	Time (min)		
		initial value	1	-40±3	30		
			2	25±2	3		
			3	125±3	30		
			4	25±2	3		
			Total: 1000	cycles	,		
			Measured	after exposure in the room con	dition for 24hrs		
1-2-2	Humidity Resistance		Temperature: 60±2°C				
			Relative Humidity: 90 ~ 95% / Time: 500hrs				
			Measured after exposure in the room condition for 24hrs				
1-2-3	High	1	Temperatu	ıre: 85±3°ℂ			
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs			
			Measured after exposure in the room condition for 24hrs				
1-2-4	Low		Temperature: -40±3°C				
	Temperature Resistance		Relative Humidity: 0% / Time: 500hrs				
			Measured	after exposure in the room con	dition for 24hrs		





Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°℃	150°C ~ 200°C	217℃	260±5°ℂ	Peak Temp. ~ 150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	8
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	8.—8

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



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MHCHL201610E Series Specification

10 Packaging:

10.1 Packaging -Cover Tape

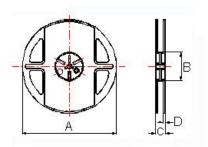
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
MHCHL201610E	3000

10.3 Reel Dimensions



Dimensions in mm

TYPE	Α	В	С	D
MHCHL201610E	178	60	12	1.5

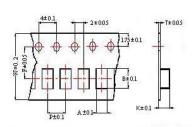


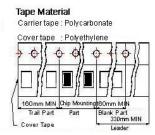
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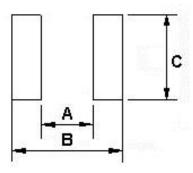
10.4 Tape Dimensions in mm





TYPE	Α	В	Т	W	Р	F	K
MHCHL201610E	1.8	2.20	0.22	8	4	3.5	1.15

11 Recommended Land Pattern:



Dimensions in mm

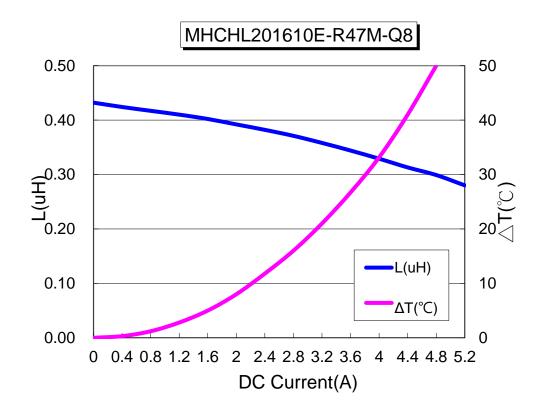
TYPE	Α	В	С
MHCHL201610E	0.7	2.3	1.8

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglectable.
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.







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